



MTTL/SECT/01/2025-26

Date: 1st April, 2025

The Secretary, Listing Department, BSE Ltd. , Phiroze Jeejeebhoy Towers, Dalal Street, Fort, Mumbai-400001. Scrip Code: 526263	The Manager, Listing Department, National Stock Exchange of India Limited , Exchange Plaza, 5 th Floor, Plot No. C/1, G Block, Bandra Kurla Complex, Bandra (E), Mumbai-400051. Symbol: MOLDTECH- EQ
---	--

Dear Sir/Madam,

Sub: Intimation in accordance with Regulation 30 of the SEBI (Listing Obligations and Disclosure Requirements) Regulations, 2015 (“Listing Regulations”)

In compliance with Regulation 30(6) read with Schedule III of the SEBI (Listing Obligations and Disclosure Requirements) Regulations, 2015, we wish to inform you that, as part of the Company's strategic business growth initiatives and the opportunities for enhancing operations globally, the Board of Directors has approved and decided to enter into a Memorandum of Understanding (MOU) with M/s. Interarch Building Solutions Limited (Interarch). This MOU aims to establish a collaborative framework wherein Mold-Tek Technologies Limited (MTTL) will provide engineering design and detailing services, while Interarch will handle manufacturing, shipping, erection, and related services for Pre-Engineered Metal Building (PEMB) and structural steel projects. Additionally, MTTL has also decided to permit Interarch to use its Atlanta office address for marketing purposes to their international clients.

The details as required under SEBI (Listing Obligations and Disclosure Requirements) Regulations, 2015 read with SEBI Circular No. SEBI/HO/CFD/CFD-PoD-1/P/CIR/2023/123 dated 13th July, 2023, is attached herewith as **Annexure-I**.

This is for your information and records.

Thanking you,

For Mold-Tek Technologies Limited

Thakur Vikram Singh
Company Secretary & Compliance Officer

Mold-Tek Technologies Limited

Regd. Off.: Plot No.700, Door No.8-2-293/82/A/700, Road No.36, Jubilee Hills, Hyderabad – 500033, Telangana, India
Phone: +91-40-40300300/01/02/03/04, Fax: +91-40-40300328, E-mail Id: cstech@moldtekindia.com
Website: www.moldtekindia.com CIN No: L25200TG1985PLC005631

Annexure-I

Details as required under SEBI (Listing Obligations and Disclosure Requirements) Regulations, 2015 read with SEBI Circular No. SEBI/HO/CFD/CFD-PoD-1/P/CIR/2023/123 dated 13th July, 2023:

Arrangements for strategic, technical, manufacturing, or marketing tie-up: Agreement / joint venture (JV) with companies:

Sl. No.	Particulars	Details
1.	Name of the entity(ies) with whom agreement/ JV is signed	Interarch Building Solutions Limited
2.	Area of agreement/JV [Memorandum of Understanding (MOU)]	Collaboration to target global markets, with a special emphasis on export orders.
3.	Domestic/International	International
4.	Share exchange ratio / JV ratio	Not Applicable
5.	Scope of business operation of agreement / JV	Mold-Tek Technologies Limited (MTTL) and Interarch Building Solutions Limited (Interarch) agree to jointly engage with clients to understand their specific building, pricing, and delivery schedule requirements. The primary point of contact for each project may vary, depending on the client's specific needs. The initial business plan outlined in the collaboration will be valid for two years from the date of execution of the MOU and may be extended upon mutual agreement between Interarch and MTTL.
6.	Details of consideration paid / received in agreement / JV	Interarch agrees to pay MTTL a commission of five percent (5%) on the value of all export orders secured as a direct result of MTTL's efforts. The commission rate may be adjusted on a project-by-project basis, at the discretion of both parties, with the objective of securing the order(s). Any adjustments to the commission will be mutually agreed upon in writing.
7.	Significant terms and conditions of agreement / JV in brief	Both parties agree to exclusively collaborate on projects introduced or to be introduced by MTTL, ensuring a dedicated partnership for these initiatives. Interarch agrees not to engage directly or through any third party with clients introduced by MTTL for similar services without MTTL's prior written consent.

Mold-Tek Technologies Limited

Regd. Off.: Plot No.700, Door No.8-2-293/82/A/700, Road No.36, Jubilee Hills, Hyderabad – 500033, Telangana, India

Phone: +91-40-40300300/01/02/03/04, Fax: +91-40-40300328, E-mail Id: cstech@moldtekindia.com

Website: www.moldtekindia.com CIN No: L25200TG1985PLC005631

8.	Whether the acquisition would fall within related party transactions and whether the promoter/ promoter group/ group companies have any interest in the entity being acquired? If yes, nature of interest and details thereof and whether the same is done at “arm’s length”	The transaction is not a related party transaction.
9.	Size of the entity(ies)	Interarch Building Products Limited has a market capitalization of approximately ₹2,530 crores.
10.	Rationale and benefit expected	To establish a collaborative framework where MTTL will provide engineering design and detailing services, while Interarch will handle/manage manufacturing, shipping, erection, and related services for Pre-Engineered Metal Building (PEMB) and structural steel projects. This collaboration seeks to harness the strengths of both parties to enhance their global business presence.

For Mold-Tek Technologies Limited

Thakur Vikram Singh
Company Secretary & Compliance Officer